



550MHz low noise current feedback amplifier

Features

■ Bandwidth: 550MHz in unity gain

■ Quiescent current: 4.1mA

Slew rate: 940V/µsInput noise: 1.5nV/√Hz

■ Distortion: SFDR=-66dBc (10MHz, 1V_{pp})

■ 2.8 V_{pp} minimum output swing on 100 Ω load for

a 5V supply

■ Tested on 5V power supply

Applications

■ Communication & video test equipment

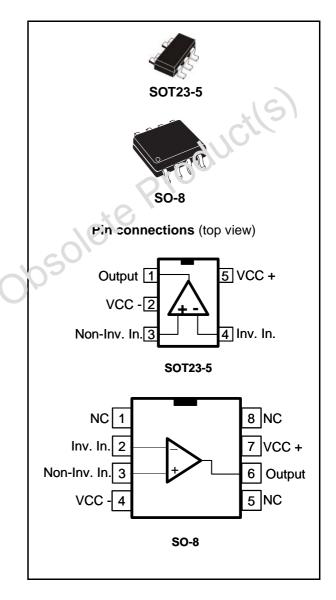
Medical instrumentation

ADC drivers

Description

The TSH350 is a current feechack operational amplifier using a very high-cuerd complementary technology to provide a bandwidth up to 410MHz while drawing only 4 1mA of quiescent current. With a slew rate of 940V/μs and an output stage optimized for criving a standard 100Ω load, this circuit is highly suitable for applications where speed and power-saving are the main recuirements.

The TSH350 is a single operator available in the tiny SOT23-5 and SO-8 plastic packages, saving board space as well as providing excellent thermal and dynamic performance.



1 Absolute maximum ratings

Table 1. Absolute maximum ratings (AMR)

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage ⁽¹⁾	6	V
V _{id}	Differential input voltage ⁽²⁾	+/-0.5	V
V _{in}	Input voltage range ⁽³⁾	+/-2.5	V
T _{stg}	Storage temperature	-65 to +150	°C
Tj	Maximum junction temperature	150	°C
R _{thja}	Thermal resistance junction to ambient SOT23-5 SO-8	250 150	°C/W
R _{thjc}	Thermal resistance junction to case SOT23-5 SO-8	80 28	°C/W
P _{max}	Maximum power dissipation ⁽⁴⁾ (@T _{amb} =25°C) for T _j =150°C SOT23-5 SO-8	500 830	mW
	HBM: human body model ⁽⁵⁾ pins 1, 4, 5, 6, 7 and 8 pins 2 and 3	2 0.5	kV
ESD	MM: machine mod'er ⁽⁶⁾ pins 1, 4, 5 လ and 8 pins 2 and 3	200 60	V
P	CDV: crarged device model ⁽⁷⁾ pirs 1, 4, 5, 6, 7 and 8 pins 2 and 3	1.5 1.5	kV
(<u>C</u>)	Latch-up immunity	200	mA

- . All voltage values are measured with respect to the ground pin.
- 2. Differential voltage is the non-inverting input terminal with respect to the inverting input terminal.
- 3. The magnitude of input and output voltage must never exceed V_{CC} +0.3V.
- 4. Short-circuits can cause excessive heating. Destructive dissipation can result from short-circuits on all amplifiers
- 5. Human body model: A 100pF capacitor is charged to the specified voltage, then discharged through a $1.5 \mathrm{k}\Omega$ resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
- 6. Machine model: A 200pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5Ω). This is done for all couples of connected pin combinations while the other pins are floating.
- 7. Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to the ground through only one pin. This is done for all pins.

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Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage ⁽¹⁾	4.5 to 5.5	V
V _{icm}	Common mode input voltage	$-V_{CC}$ +1.5V to +V _{CC} -1.5V	٧
T _{oper}	Operating free air temperature range	-40 to + 85	°C

^{1.} Tested in full production at 5V (±2.5V) supply voltage.

Obsolete Product(s). Obsolete Product(s)

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Electrical characteristics TSH350

2 Electrical characteristics

Table 3. Electrical characteristics for $V_{CC} = \pm 2.5V$, $T_{amb} = 25^{\circ}C$ (unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
DC perfor	mance			I	l	
	Input offset voltage	T _{amb}		0.8	4	\/
V_{io}	Offset voltage between both inputs	$T_{min} < T_{amb} < T_{max}$		1		mV
ΔV_{io}	V _{io} drift vs. temperature	$T_{min} < T_{amb} < T_{max}$		0.9		μV/°C
ı	Non inverting input bias current	T _{amb}		12	35	
I _{ib+}	DC current necessary to bias the input +	$T_{min} < T_{amb} < T_{max}$		13		PA
I	Inverting input bias current	T _{amb}		1	20	μА
I _{ib-}	DC current necessary to bias the input -	$T_{min} < T_{amb} < T_{max}$		2.5		μΑ
CMR	Common mode rejection ratio	$\Delta V_{ic} = \pm 1 V$	56	60		dB
OWIT	20 log $(\Delta V_{ic}/\Delta V_{io})$	$T_{min} < T_{amb} < T_{ma}$		58		ub.
SVR	Supply voltage rejection ratio	ΔV _{CC} =+3.5V ιο +εν	68	81		dB
OVIC	20 log $(\Delta V_{\rm CC}/\Delta V_{\rm io})$	$T_{min} < T_{\epsilon mh} < T_{max}$		78		ub.
PSR	Power supply rejection ratio	$A_{V} = +1$, $\Delta V_{CC} = \pm 100$ mV at TkHz		51		dB
	20 log (ΔV _{CC} /ΔV _{out)}	$T_{min} < T_{amb} < T_{max}$		48		
I _{CC}	Positive supply current DC consumption with no irrput signal	No load		4.1	4.9	mA
Dynamic _I	performance and orແກ່ນ characteristics			·		·
	Transimpodance	$\Delta V_{\text{out}} = \pm 1 \text{V}, R_{\text{L}} = 100 \Omega$	170	270		kΩ
R _{OL}	Output vo." age/input current gain in open loop or a CrA. Col a VFA, the analog of this feature is the lopen loop gain (A _{VD})	$T_{min} < T_{amb} < T_{max}$		250		kΩ
Bw	-3dB bandwidth Frequency where the gain is 3dB below the DC gain A _V Note: Gain bandwidth product criterion is not applicable for current-feedback-amplifiers	$\begin{array}{l} \text{Small signal} \\ \text{V_{out}=$20m$V$_{pp}} \\ \text{$A_{V}$ = +1, R_{L} = 100Ω} \\ \text{A_{V} = +2, R_{L} = 100Ω} \\ \text{A_{V} = +10, R_{L} = 100Ω} \\ \text{A_{V} = -2, R_{L} = 100Ω} \end{array}$	250	550 390 125 370		MHz
	Gain flatness @ 0.1dB Band of frequency where the gain variation does not exceed 0.1dB	$ \begin{aligned} & \text{Small signal} \\ & \text{V}_{\text{out}} \text{=} 100 \text{mV}_{\text{p}} \\ & \text{A}_{\text{v}} = \text{+} 1, \text{R}_{\text{L}} = 100 \Omega \end{aligned} $		65		_
SR	Slew rate Maximum output speed of sweep in large signal	$V_{out} = 2V_{pp}, A_V = +2,$ $R_L = 100\Omega$		940		V/μs
V	High level output voltage	$R_L = 100\Omega$	1.44	1.56		V
V _{OH}	High level output voltage	$T_{min} < T_{amb} < T_{max}$		1.49		

TSH350 Electrical characteristics

Table 3. Electrical characteristics for $V_{CC} = \pm 2.5V$, $T_{amb} = 25^{\circ}C$ (unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
\/	Low lovel output voltage	$R_L = 100\Omega$		-1.53	-1.44	V
V_{OL}	Low level output voltage	$T_{min} < T_{amb} < T_{max}$		-1.49		
	I _{sink}	Output to GND	135	205		
	Short-circuit output current coming in the opamp (see <i>Figure 9</i>)	$T_{min} < T_{amb} < T_{max}$		195		mA
lout	I _{source}	Output to GND	-140	-210		IIIA
	Output current coming out from the op-amp (see <i>Figure 10</i>)	$T_{min} < T_{amb} < T_{max}$		-185		
Noise and	distortion				10	3)
eN	Equivalent input noise voltage See Section 5: Noise measurements	F = 100kHz		1.5	Cil	nV/√Hz
iN	Equivalent input noise current (+) See Section 5: Noise measurements	F = 100kHz) (O	20		pA/√Hz
IIN	Equivalent input noise current (-) See Section 5: Noise measurements	F = 100kHz		13		pA/√Hz
SFDR	Spurious free dynamic range The highest harmonic of the output spectrum when injecting a filtered sine wave	$A_{V} = +1, V_{C,h} = 1V_{pp}$ $F = 10M_{1}^{1/2}$ $F = 2CMHz$ $F = 50MHz$ $F = 100MHz$		-66 -57 -46 -42		dBc

Table 4. Closed-loop gain and fe rabect components

V _{CC} (V)	Gain	R _{fb} (Ω)	-3dB Bw (MHz)	0.1dB Bw (MHz)
	+'0	300	125	22
	-10	300	120	20
±2.5	+2	300	390	110
±2.5	-2	300	370	70
60/0	+1	820	550	65
03	-1	300	350	120

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Figure 1. Frequency response, positive gain Figure 2. Frequency response, negative gain

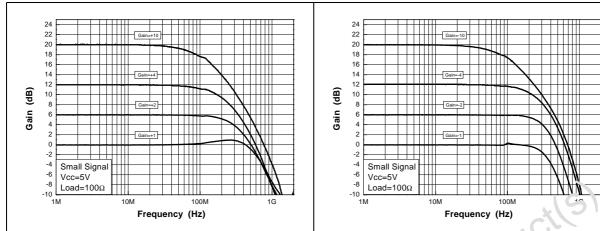


Figure 3. Compensation, gain=+4

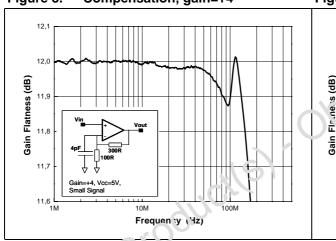


Figure 4. Compensation, value+2

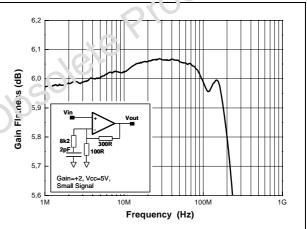
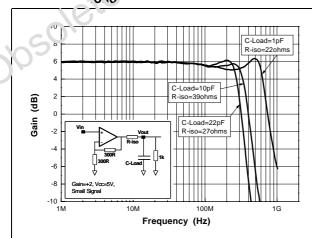


Figure 5. Frequency response vs. capacitor Figure 6. Step response vs. capacitor load



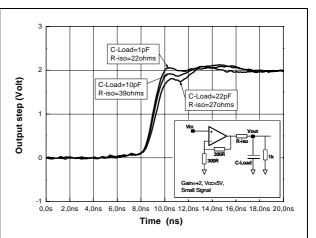


Figure 7. Slew rate

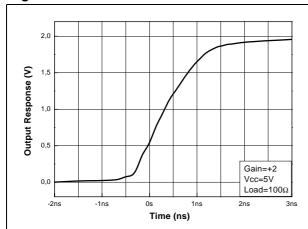


Figure 8. Output amplitude vs. load

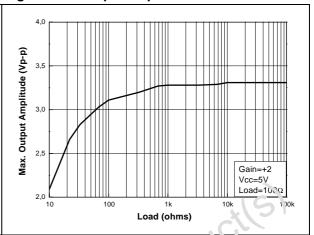


Figure 9. I_{sink}

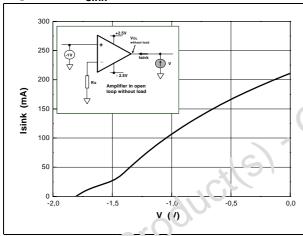


Figure 10. I_{source}

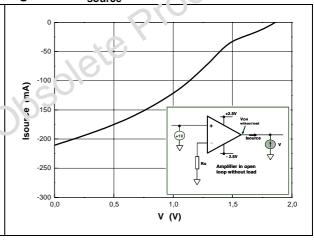


Figure 11. Input current noise vs. frequency

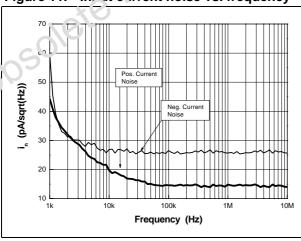
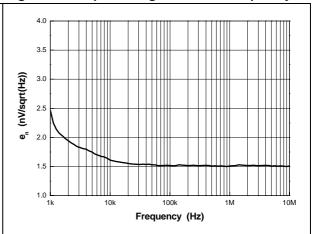


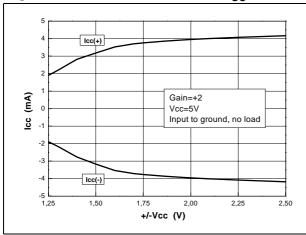
Figure 12. Input voltage noise vs. frequency

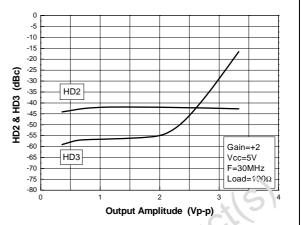


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Figure 13. Quiescent current vs. V_{CC}

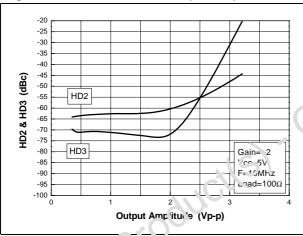
Figure 14. Distortion vs. output amplitude

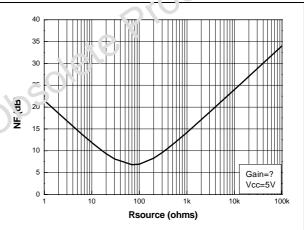




Distortion vs. output amplitude

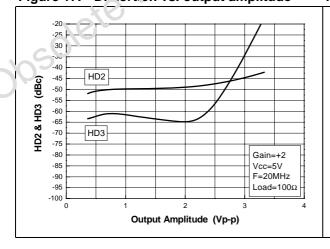
Figure 16. Noise figure





Distortion vs. output amplitude Figure 17.

Figure 18. Output amplitude vs. frequency



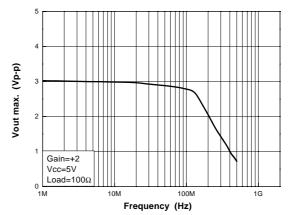
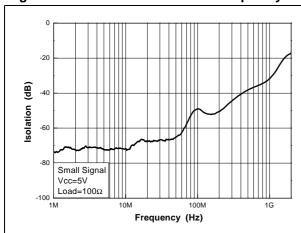


Figure 19. Reverse isolation vs. frequency





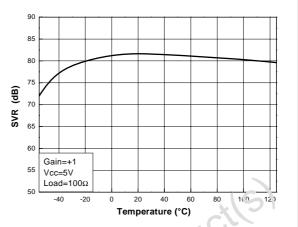
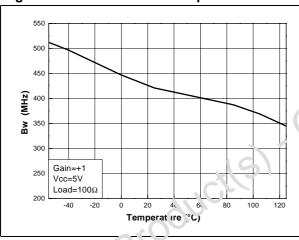


Figure 21. Bandwidth vs. temperature

Figure 22. R_{OL} vs. tempera ura



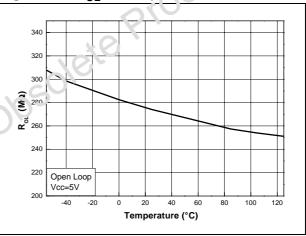
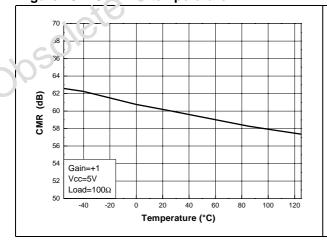
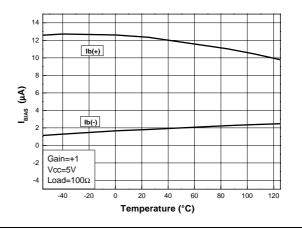


Figure 23. CMR vs. temperature

Figure 24. I_{bias} vs. temperature



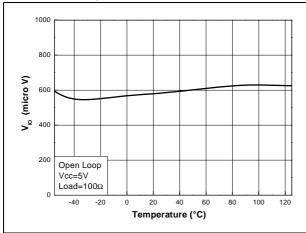


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Figure 25. V_{io} vs. temperature

Figure 26. I_{CC} vs. temperature



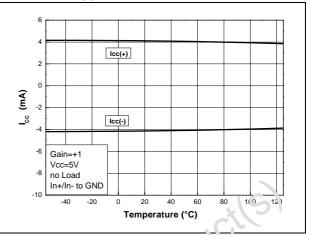
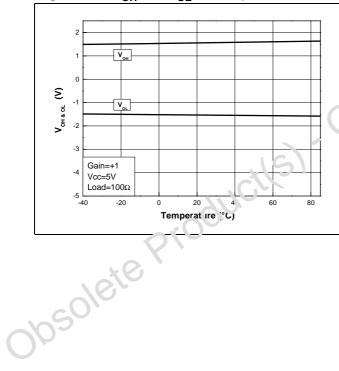
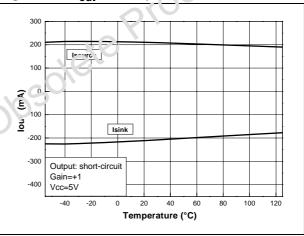


Figure 27. V_{OH} and V_{OL} vs. temperature

Figure 28. I_{out} vs. temperature.





TSH350 Evaluation boards

3 Evaluation boards

An evaluation board kit optimized for high-speed operational amplifiers is available (order code: KITHSEVAL/STDL). As well as a CD-ROM containing datasheets, articles, application notes and a user manual, the kit includes the following evaluation boards:

- SOT23_SINGLE_HF BOARD
 Board for the evaluation of a single high-speed op-amp in SOT23-5 package.
- SO8_SINGLE_HF
 Board for the evaluation of a single high-speed op-amp in SO-8 package.
- SO8_DUAL_HF
 Board for the evaluation of a dual high-speed op-amp in SO-8 package.
- SO8_S_MULTI
 Board for the evaluation of a single high-speed op-amp in SO-8 package in inverting and non-inverting configuration, dual and single supply.
- SO14_TRIPLE
 Board for the evaluation of a triple high-speed op-amp in SO-14 package with video application considerations.

Board material:

- 2 layers
- FR4 (εr=4.6)
- epoxy 1.6mm
- copper thickness: 35um

Figure 29. Evaluation kit for high-speed op-amps



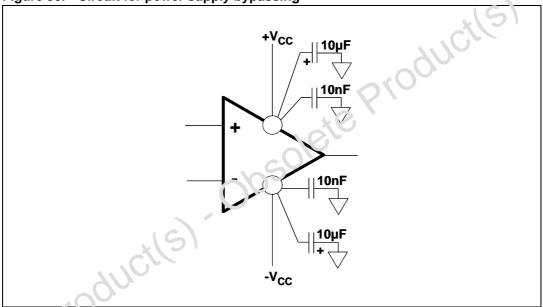
4 Power supply considerations

Correct power supply bypassing is very important for optimizing performance in high-frequency ranges. Bypass capacitors should be placed as close as possible to the IC pins to improve high-frequency bypassing. A capacitor greater than $1\mu F$ is necessary to minimize the distortion. For better quality bypassing, a capacitor of 10nF can be added which should also be placed as close as possible to the IC pins.

Bypass capacitors must be incorporated for both the negative and the positive supply.

Note: On the SO8_SINGLE_HF board, these capacitors are C6, C7, C8, C9.

Figure 30. Circuit for power supply bypassing



Single power supply

In the event that a single supply system is used, biasing is necessary to obtain a positive output dynamic range between 0V and $+V_{CC}$ supply rails. Considering the values of V_{OH} and V_{OL} , the amplifier will provide an output swing from +0.9V to +4.1V on a 100Ω load.

The amplifier must be biased with a mid-supply (nominally $+V_{CC}/2$), in order to maintain the DC component of the signal at this value. Several options are possible to provide this bias supply, such as a virtual ground using an operational amplifier or a two-resistance divider (which is the cheapest solution). A high resistance value is required to limit the current consumption. On the other hand, the current must be high enough to bias the non-inverting input of the amplifier. If we consider this bias current (35 μ A maximum) as 1% of the current through the resistance divider, to keep a stable mid-supply, two resistances of 750 Ω can be used.

The input provides a high-pass filter with a break frequency below 10Hz which is necessary to remove the original 0 volt DC component of the input signal, and to fix it at $+V_{CC}/2$.

Figure 31 illustrates a 5V single power supply configuration for the SO8_S_MULTI evaluation board (see *Evaluation boards* on page 11).

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A capacitor C_G is added in the gain network to ensure a unity gain in low frequency to keep the right DC component at the output. C_G contributes to a high-pass filter with $R_{fb}/\!/R_G$ and its value is calculated with a consideration of the cut off frequency of this low-pass filter.

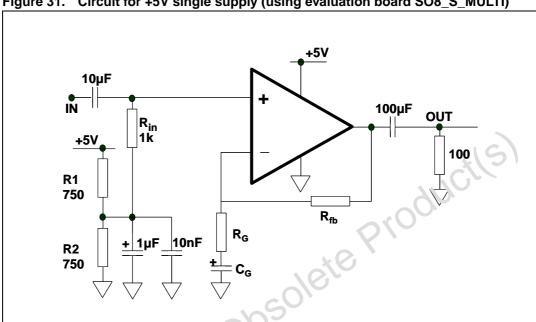


Figure 31. Circuit for +5V single supply (using evaluation board SO8_S_MULTI)

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Obsolete Product(s)

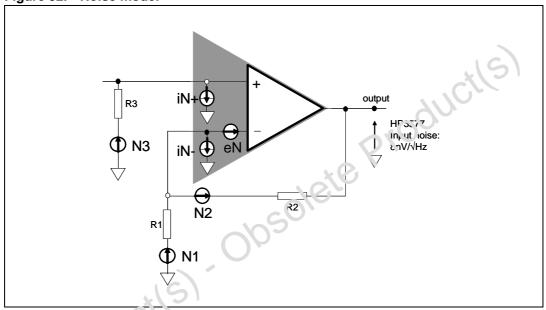
Noise measurements TSH350

5 Noise measurements

The noise model is shown in Figure 32:

- eN is the input voltage noise of the amplifier
- iNn is the negative input current noise of the amplifier
- iNp is the positive input current noise of the amplifier

Figure 32. Noise model



The thermal noise of a resistance R is

 $\sqrt{4kTR\Delta F}$

where ΔF is the specified bandwidth.

On a 1Hz bandwidth the thermal noise is reduced to:

 $\sqrt{4kTR}$

where k is the Boltzmann's constant, equal to 1,374.10-23J/°K. T is the temperature (°K).

The output noise eNo is calculated using the Superposition Theorem. However, eNo is not the simple sum of all noise sources, but rather the square root of the sum of the square of each noise source, as shown in *Equation 1*:

Equation 1

$$eNo = \sqrt{V1^2 + V2^2 + V3^2 + V4^2 + V5^2 + V6^2}$$

TSH350 Noise measurements

Equation 2

$$eNo^2 = eN^2 \times g^2 + iNn^2 \times R2^2 + iNp^2 \times R3^2 \times g^2 + \frac{R2^2}{R1} \times 4kTR1 + 4kTR2 + 1 + \frac{R2^2}{R1} \times 4kTR3$$

The input noise of the instrumentation must be extracted from the measured noise value. The real output noise value of the driver is:

Equation 3

$$eNo = \sqrt{(Measured)^2 - (instrumentation)^2}$$

The input noise is called **equivalent input noise** because it is not directly measured but is evaluated from the measurement of the output divided by the closed loop gain (e.Nc/g).

After simplification of the fourth and the fifth term of Equation 2 we obtain:

Equation 4

$$eNo^{2} = eN^{2} \times g^{2} + iNn^{2} \times R2^{2} + iNp^{2} \times R3^{2} \times g^{2} + r \times 4k R2 + 1 + \frac{R2}{R1}^{2} \times 4kTR3$$

Measurement of the input voltage noise eN

If we assume a short-circuit on the non-ir verting input (R3=0), from *Equation 4* we can derive:

Equation 5

eNo
$$\sqrt{2N^2 \times g^2 + iNn^2 \times R2^2 + g \times 4kTR2}$$

In order to easily extract the value of eN, the resistance R2 will be chosen to be as low as possible. In the other hand, the gain must be large enough:

Measurement of the negative input current noise iNn

To measure the negative input current noise iNn, we set R3=0 and use *Equation 5*. This time, the gain must be lower in order to decrease the thermal noise contribution:

Measurement of the positive input current noise iNp

To extract iNp from *Equation 3*, a resistance R3 is connected to the non-inverting input. The value of R3 must be chosen in order to keep its thermal noise contribution as low as possible against the iNp contribution:

6 Intermodulation distortion product

The non-ideal output of the amplifier can be described by the following series:

$$V_{out} = C_0 + C_1 V_{in} + C_2 V_{in}^2 + ... + C_n V_{in}^n$$

where the input is V_{in} =Asin αt , C_0 is the DC component, $C_1(V_{in})$ is the fundamental and C_n is the amplitude of the harmonics of the output signal V_{out} .

A one-frequency (one-tone) input signal contributes to harmonic distortion. A two-tone input signal contributes to harmonic distortion and to the intermodulation product.

The study of the intermodulation and distortion for a two-tone input signal is the first step in characterizing the driving capability of multi-tone input signals.

In this case:

$$V_{in} = A \sin \omega_1 t + A \sin \omega_2 t$$

then:

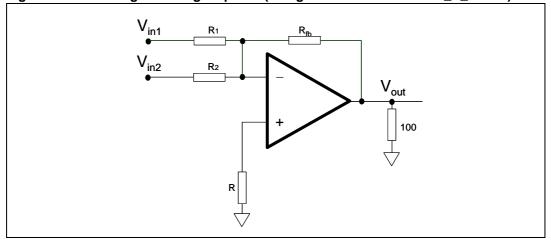
$$V_{out} = C_0 + C_1 (A \sin \omega_1 t + A \sin \omega_2 t) + C_2 (A \sin \omega_1 t + A \sin \omega_2 t)^2 ... + C_n (A \sin \omega_1 t + A \sin \omega_2 t)^n$$

From this expression, we can extract the distortion terms, and the intermodulation terms from a single sine wave:

- second order interr. odulation terms IM2 by the frequencies (ω₁-ω₂) and (ω₁-ω₂) with an amplitude of C2A²
- third order in a modulation terms IM3 by the frequencies $(2\omega_1-\omega_2)$, $(2\omega_1+\omega_2)$, $(-\omega_1+2\omega_2)$ and $(\omega_1-2\omega_1)$ with an amplitude of $(3/4)C3A^3$

The intermodulation product of the driver is measured by using the driver as a mixer in a sumining amplifier configuration (see *Figure 33*). In this way, the non-linearity problem of an external mixing device is avoided.

Figure 33. Inverting summing amplifier (using evaluation board SO8_S_MULTI)



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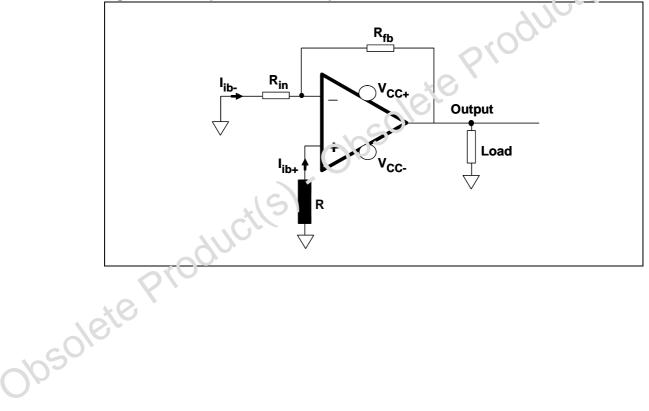
7 Inverting amplifier biasing

A resistance is necessary to achieve good input biasing, such as resistance R shown in *Figure 34*.

The magnitude of this resistance is calculated by assuming the negative and positive input bias current. The aim is to compensate for the offset bias current, which could affect the input offset voltage and the output DC component. Assuming I_{ib} , I_{ib+} , R_{in} , R_{fb} and a zero volt output, the resistance R is:

$$R = \frac{R_{in} \times R_{fb}}{R_{in} + R_{fb}}$$





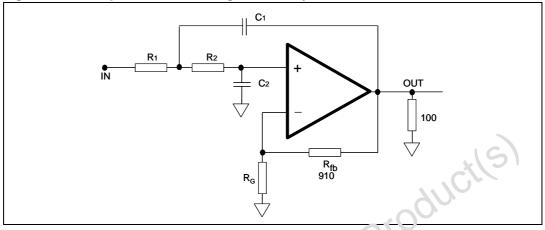
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Active filtering TSH350

8 Active filtering

Downloaded from Arrow.com.

Figure 35. Low-pass active filtering, Sallen-Key



From the resistors R_{fb} and R_{G} we can directly calculate the g_{ϵ} in of the filter in a classic non-inverting amplification configuration:

$$A_V = g = 1 + \frac{P_{fb}}{P_{ga}}$$

We assume the following expression as the response of the system:

$$T_{j\omega} = \frac{Vout_{j\omega}}{Vin_{j\omega}} = \frac{g}{1 + 2\zeta \frac{j\omega}{\omega_c} + \frac{(j\omega)^2}{\omega_c^2}}$$

The cut-off frequency is not gain-dependent and so becomes:

$$\omega_{\rm c} = \frac{1}{\sqrt{R1R2C1C2}}$$

The damping factor is calculated by the following expression:

$$\zeta = \frac{1}{2}\omega_{c}(C_{1}R_{1} + C_{1}R_{2} + C_{2}R_{1} - C_{1}R_{1}g)$$

The higher the gain, the more sensitive the damping factor is. When the gain is higher than 1, it is preferable to use some very stable resistor and capacitor values. In the case of R1=R2=R:

$$\zeta = \frac{2C_2 - C_1 \frac{R_{fb}}{R_g}}{2\sqrt{C_1 C_2}}$$

Due to a limited selection of values of capacitors in comparison with resistors, we can set C1=C2=C, so that:

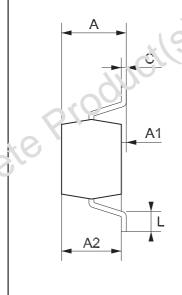
$$\zeta = \frac{2R_2 - R_1 \frac{R_{fb}}{R_g}}{2\sqrt{R_1 R_2}}$$

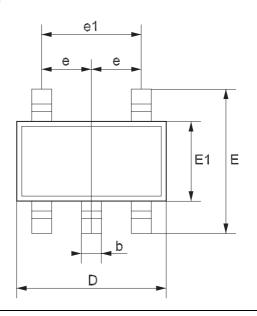
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Figure 36. SOT23-5 package mechanical data

			Dime	nsions		
Ref.		Millimeters			Mils	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.00		5.9
A2	0.90		1.30	35.4		51.?
b	0.35		0.50	13.7		19.7
С	0.09		0.20	3.5	1110	7.8
D	2.80		3.00	110.2	00	118.1
E	2.60		3.00	102.5		118.1
E1	1.50		1.75	59.0		68.8
е		0.95		SI	37.4	
e1		1.9	c0		74.8	
L	0.35		0.55	13.7		21.6

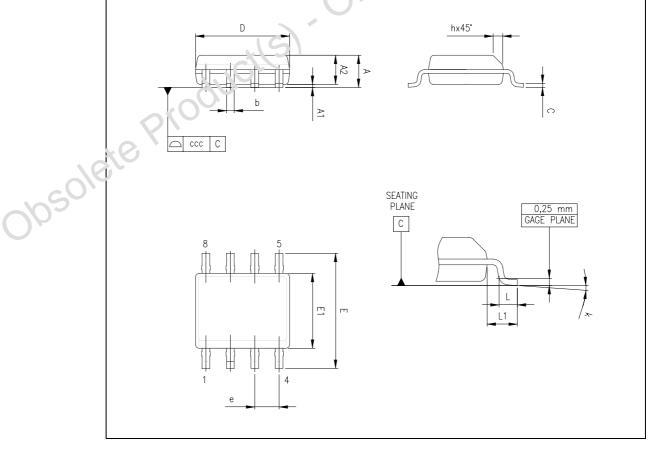




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Figure 37. SO-8 package mechanical data

			Dime	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
С	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
Н	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
е		1.27).050	
h	0.25		0.50	0.010	·	0.020
L	0.40		1.27	0.016		0.050
k	1°		8°	1°		8°
ccc			7.10			0.004



TSH350 Ordering information

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Table 5. **Order codes**

Part number	Temperature range	Package	Packing	Marking
TSH350ILT		SOT23-5	Tape & reel	K305
TSH350ID	-40°C to +85°C	SO-8	Tube	TSH350I
TSH350IDT		SO-8	Tape & reel	TSH350I

11 **Revision history**

Date	Revision	Charges
1-Oct-2004	1	First release corresponding to Oreliminary Data version of datashe
10-Dec-2004	2	Release of mature product datasheet.
21-Jun-2005	3	In <i>Table 1</i> on page 2. Rujc thermal resistance junction to ambient replaced by the armac! resistance junction to case.
8-Jun-2007	4	Format undate.
	ductl	

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